SPECIFICATION FOR APPROVAL

CUSTOMER:	鹿鸣
CUSTOMER P/N	
PART NO:	
DESCRIPTION:	SMD POWER INDUCTORS
PRODUCTS NO:	CYSCM9070FTL-SERIES
PRODUCTS REV:	1
DATE:	2018-7-19

PURCHASER CONFIRMED		
REMARK		

PROVIDER ENGINEER DEPT.		
APPROVAL BY CHECK BY DRAWN BY		
		chenlinli

誠陽實業有限公司

TAIWAN CHENG YANG COMPONENT CORP

2F-1, NO. 176, Chine-Yi Road., Zhonghe District, New Taipei City,

新北市中和區建一路176號2樓之一

POSTAL CODE: 23500

TEL NO.:+886-2-8228-0930 FAX NO.:+886-2-8228-0929 E-

寶誠電子有限公司

ZHUHAI BAO CHENG ELECTRONICSCO.,LTD

Guan Tang Industrial Park, Tang Jia Wan Town, Zhuhai City, Guangdong

中國廣東省珠海市塘家灣鎮官塘工業區

POSTAL CODE: 519085

TEL NO:86-756-3383187 FAX NO:86-756-3380704 E-mail:

昆山誠陽電子有限公司

KUNSHAN CHENG YANG ELECTRONICSCO.,LTDP

Qiang-An Road., High-Tech. Industrial Park, Kunshan City, Jiangsu Province,

江蘇省昆山市高科技工業園區強安路38號 POSTAL CODE: 215300

TEL NO:86-512-57823500 FAX NO:86-512-57823503 E-mail: kscy@taiwan-che





CHENG

TAIPEI OFFICE



REVISION NOTES

NO.	Date	Description of Revision
1	2018-7-19	首次送樣
<u> </u>	<u> </u>	

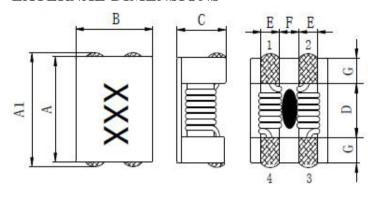
ROHS Compliant

UNIT: mm

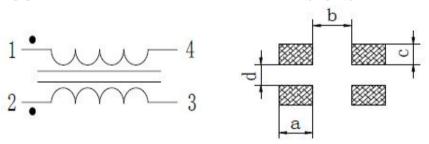
TEST DATADIMENSION&ELECTRIC CHARACTER

CUSTOME	鹿鸣	PART NO.:	
ΓOMER :	SMD INDUCTOR	SERIES NO:	CYSCM9070FTL-SERIES

EXTERNAL DIMENSIONS



RECOMMEND LAND PATTERN DIMENSIONS



A	9.0±0.5
A1	9.5±0.6
В	7.0±0.5
С	4.8MAX
D	5.7REF
Е	1.5±0.5
F	2.0±0.5
G	1.7±0.5
a	3.00
b	5.00
С	2.20
d	1.80

Part NO.	Impedance (Ω)	DCR (mΩ)	Rated Current (A)	Test Freq	MARKING
CYSCM9070FTL-301	225Min (300TYP)	6 MAX	6 MAX	100MHz	301
CYSCM9070FTL-501	450Min (600TYP)	8 MAX	6 MAX	100MHz	501
CYSCM9070FTL-701	500Min (700TYP)	10 MAX	5 MAX	100MHz	701
CYSCM9070FTL-102	750Min(1000TYP)	13 MAX	4 MAX	100MHz	102
CYSCM9070FTL-222	1700Min (2200TYP)	60 MAX	2.5 MAX	100MHz	222
CYSCM9070FTL-272	2000Min (2700TYP)	65 MAX	2.0 MAX	100MHz	272
CYSCM9070FTL-302	2500Min (3000TYP)	70 MAX	1.9 MAX	100MHz	302

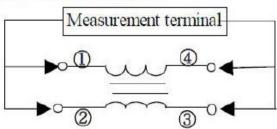
Rated Current: $\Delta T \leq 40^{\circ}C$ Typ

NOTE:

Operating temperature: '-40 $^{\circ}\text{C}\!\sim\!\!+125\,^{\circ}\text{C}$

storage: 温度: 0℃~+40℃ 湿度: RH10%~70%

Impedance TEST EQUIPMENT



APPROVED BY: Vincent CHECKED BY: Yasir

DRAWN BY: chenlinli

TEST DATADIMENSION&ELECTRIC CHARACTER

CUSTOME	鹿鸣	PART NO.:	
FOMER :	SMD INDUCTOR	SERIES NO:	CYSCM9070FTL-SERIES
Curve			
10000 1000 CG 1000 1000 1000 1000 1000 1		Mode SCM9070	Differential Mode
10000 SC 10000 CC 90000 1000 1000 1000 1000 100		10000 SCM907	OFTL-102 Common Mode Differential Mode 10 100 1000 Frequency(MHz)
10000 1000 CC 1000 1000 1000		10000 SCM901	Common Mode Differential Mode 10 100 1000 Frequency(MHz)
APPROV			PREPARED BY
Vinc	eent Yas	SII	chenlinli

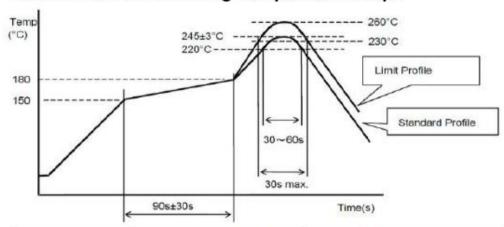
TEST DATA

DIMENSION&ELECTRIC CHARACTER

CUSTOME	鹿鸣	PART NO.:	
ΓOMER :	SMD INDUCTOR	SERIES NO:	CYSCM9070FTL-SERIES

Ma	iterial List				
No	Item	Material	Specification	Supplier	UL
a	Core	Ferrite core	I CORE	SINCORE OR EQU	
b	Wire	Enamelled copper wire	G1P180	ELEKTRISOA OR EQU	E258243
С	Base	Plastic	CS-SCM9070-DY	DY OR EQU	
d	Adhesive	Epoxy resin	ST-500	ST OR EQU	
е	Terminal	Sn /Cu	Sn99.3:Cu0.7	THOUSAND OR EQU	

Recommended Soldering Temperature Graph



	Standard Profile	Limit Profile
Pre-heating	150~180°	C 、90s±30s
Heating	above 220℃、30s-60s	above 240℃、30s max
Peak temperature	245℃±3℃	260℃、10s
Cycle of reflow	2 times	2 times

Product photos



APPROVED BY	CHECKED BY	PREPARED BY
Vincent	Yasir	chenlinli

■ GENERAL CHAR	ACTERISTICS	page. 1	
Operation Temperature	-40°C to +125°C (Includes temperature when the coil	l is heated)	
External Appearance	On visual inspection, the coil has no external defects.		
	More than 90% of terminal electrode should be covered with solder.		
Solder Ability Test	Solder:bath at 235 °C \pm 5 °C for 5 \pm 0.5senonds	Preheating Dipping Natural cooling	
Heat endurance of Soldering	1.Components should have not evidence of electrical 2.Inductance: within±10% of initial value. 3.Impedance: within±10% of initial value. Preheat:150±5°C 60seconds. Solder temperature: 250±5°C. Flux: rosin. Dip time:10±0.5seconds.	Preheating Dipping Natural cooling	
Terminal Strength	After soldering of X,Y withstanding at below condition off. (Refer to figure at below)	ons .The terminal should not Peel	
Insulating Resistance	Over $100M\Omega$ at $100V$ D.C. between coil and core.		
Dielectric Strength	No dielectric breakdown at 30V D.C. for 1 minute be	etween coil and core.	
VibrationTest	Inductance deviation within +10% after vibration for orientations at sweep vibration(10-~55-~10HZ)with	1.5mmP-P amplitudes	
Drop test	Inductance deviation within +10% after being dropped shock Attitude upon a rubber block method shock te orientations		

v Application Notice/Handling

1. Storage Conditions

To maintain the solder ability of terminal electrodes:

- (1) Temperature and humidity conditions: less than 40°C and 70% RH.
- (2) Products should be used within 6 months.
- (3) The packaging material should be kept where no chlorine or sulfur exists in the air.
- 2. Handling
- (1) Do not touch the electrodes(soldering terminals) with fingers as this may lead to deterioration of solderability.
- (2) The use of tweezers or vacuum pick-ups is strongly recommended for individual components.
- (3) Bulk handling should ensure that abrasion and mechanical shock are minimized.

■ GENERAL CHARACTE	ERISTICS	page. 2
TEST	Required Characteristics	Test Method/Condition
High Temperature StorageTest Reference documents: MIL-STD-202G Method108A	 No case deformation or change in appearance △L/L≤10% △Q/Q≤30% △DCR/DCR≤10% 	High temperature 25°C High temperature 1H 1H 96H Test Time Temperature: 125°C±2°C Time: 96±2 hours. Tested not less than 1 hour, nor more than 2 hours at room.
Low Temperature Storage Test Reference documents: IEC 68-2-1A 6.1 6.2	 No case deformation or change in appearance △L/L≦10% △Q/Q≦30% △DCR/DCR≦10% 	
Humidity Test Reference documents: MIL-STD-202G Method103B	 No case deformation or change in appearance ΔL/L≤10% ΔQ/Q≤30% ΔDCR/DCR≤10% 	
Thermal Shock Test Reference documents: MIL-STD-202G Method107G	 No case deformation or change in appearance △L/L≤10% △Q/Q≤30% △DCR/DCR≤10% 	First-40°C for 30 Minutes, last 125°C for 30 Minutes as 1 cycle. Go through 20 cycles.

■Application Notice/Handling

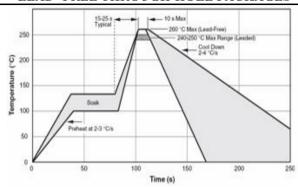
- (1) Temperature and humidity conditions: less than 40°C and 70% RH.
- (2) Products should be used within 6 months.
- (3) The packaging material should be kept where no chlorine or sulfur exists in the air.
- (4) Do not touch the electrodes (soldering terminals) with fingers as this may lead to deterioration of solder ability
- (5) The use of tweezers or vacuum pick-ups is strongly recommended for individual components.
- (6) Bulk handling should ensure that abrasion and mechanical shock are minimized.

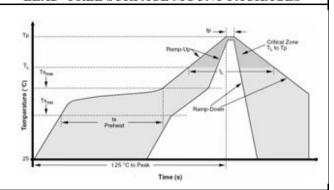
■THE CONDITION OF REFLOW(RECOMMENDATION)

page. 3

TYPICAL WAVE SOLDER PROFILE FOR LEAD -FREE THROUGH-HOLE PACKAGES

TYPICAL IR REFLOW PROFILE FOR LEADED AND LEAD -FREE SURFACE MOUNT PACKAGES





IPC/JEDEC J-STD-020C, Figure 5-1

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly 3 °C/second max.	
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.		
Preheat ± Temperature Min (Ts _{min}) ± Temperature Max (Ts _{max}) ± Time (ts _{min} to ts _{max})	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-180 seconds	
Time maintained above: ± Temperature (T _L) ± Time (t _L)	183 °C 60-150 seconds	217 °C 60-150 seconds	
Peak/Classification Temperature (Tp)	See Table 4.1	See Table 4.2	
Time within 5 °C of actual Peak Temperature (tp)	10-30 seconds	20-40 seconds	
Ramp-Down Rate	6 °C/second max.	6 °C/second max.	
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.	

Table 4. Classification Reflow Profiles (per IPC/JEDEC J-STD-020C, Table 5.2)

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5 mm	240 +0/-5 °C	225 +0/-5 °C
≥2.5 mm	225 +0/-5 °C	225 +0/-5 °C

Table 5. SnPb Eutectic Process - Package Peak Reflow Temperatures (per IPC/JEDEC J-STD-020C, Table 4.1)

Package Thickness	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 + 0 °C *	260 + 0 °C *	260 + 0 °C *
1.6 mm - 2.5 mm	260 + 0 °C *	250 + 0 °C *	245 + 0 °C *
≥2.5 mm	250 + 0 °C *	245 + 0 °C *	245 + 0 °C *

^{*} Tolerance: Process compatibility is up to and including the stated classification temperature (this means Peak reflow temperature + 0 °C. For example 260 °C + 0 °C) at the rated MSL level.

Table 6. Pb-free Process - Package Classification Reflow Temperatures (per IPC/JEDEC J-STD-020C, Table 4.2)

Note 1: The profiling tolerance is +0 °C, -X °C (based on machine variation capability) whatever is required to control the profile process but at no time will it exceed -5 °C. Process compatibility at the peak reflow profile temperatures as defined in Table 4.2.

Note 2: Package volume excludes external terminals (balls, bumps, lands, leads) and/or nonintegral heat sinks.

Note 3: The maximum component temperature reached during reflow depends on package thickness and volume. The use of convection reflow processes reduces the thermal gradients between packages. However, thermal gradients due to differences in thermal mass of SMD packages may still exist.

Note 4: Components intended for use in a "lead-free" assembly process shall be evaluated using the "lead-free" classification temperatures and profiles defined in Tables 4.1, 4.2 and 5.2 whether or not lead free.

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744252510 T8116NLT CMS2-10-R DLW44SN101SK2L FE2X10-4-2NL 744253200 744253101 744252220 TX8111NLT
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